Contact resistance and current crowding in tunneling type circular nano-contacts

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Abstract

Current transport and contact resistance in nanoscale electrical contacts are important to the overall device properties, especially for devices based on novel one-dimensional and two-dimensional materials or nanostructures. In this paper, we present a self-consistent method to model tunneling type circular thin film contacts. We solve the lumped circuit circular transmission line model (CTLM) with tunneling-induced specific contact resistivity \( \rho_c \) which varies along the radial direction. The contacting members are separated by a thin insulating layer, where the radially dependent \( \rho_c \) is calculated from local voltage dependent tunneling current density. The current and voltage distributions in such contacts and their overall contact resistance are studied in detail, for various input voltages, contact dimensions, and material properties (i.e. work function, sheet resistance of the contact members, and permittivity of the insulating layer). Our study shows that the contact resistance is voltage dependent, and the radial current distribution is strongly nonhomogeneous. The contact resistance and the current distribution can be controlled by engineering the contact layer properties and geometry radially. Although focused on Schrödinger tunneling type contacts in this work, our modified CTLM equations with radially varying \( \rho_c \) are general, and may be readily used for other types of electrical contacts, such as ohmic and Schottky contacts.

Keywords: contact resistance, current crowding, quantum tunneling, circular electrical contact

(Some figures may appear in colour only in the online journal)

1. Introduction

Current transport and contact resistance in nanoscale electrical contacts are recently being studied extensively to meet the growing demands for the physical shrinking of electronic circuits [1]. Advancements in the development of novel one-dimensional (1D) and two-dimensional (2D) materials and nanostructure-based devices have also contributed to the growing research interest in electrical contacts [2–4]. Although popular for their unique electrical and mechanical properties, the nanowire, nanotube, nanorod, and nanofiber-based devices face serious challenges because of a large number of electrical contacts usually present in the circuit. Electrical properties in these nano contacts impact the controllability, reliability, and efficiency of the overall device [5, 6]. Moreover, contact resistance in electronic devices composed of a single layer or multilayer 2D material based thin films (e.g. graphene, boron nitride, molybdenum sulfide, black phosphorus, tungsten disulfide, etc), restricts their large-scale industrial production [7]. Hence, controlling current transport in nanocontacts is a fundamental step towards many technological breakthroughs.

For decades, the transmission line model (TLM) has been widely used with great success to analyze electrical properties in nano-scale and meso-scale contacts [8–14]. Recently Banerjee et al [15] modified the conventional TLM for parallel Cartesian nanocontacts including the effects of spatially varying specific contact resistivity \( \rho_c \). In this paper, we extend that work to demonstrate a 2D circular transmission line model (CTLM) for circular and annular nanocontacts. Circular tunneling contacts may be formed between two thin films or between a thin film substrate and a standing cylindrical nanorod (or nanofiber) as in the configuration of field emitters [16, 17]. Like [15], our model is two-dimensional in the sense...
that we consider radial variation in the contact resistivity \( \rho_c \), which may be introduced by a variety of factors. For instance, the inherent non-linearity of the current density-voltage \( (J-V) \) profiles of tunneling [18, 19] and Schottky junctions [20] may lead to strong radial dependence of the electrical properties in practical 2D contacts. Radial variation of the interfacial layer thickness for tunneling type contacts and nonuniform distribution of contaminants or impurities in the contact layer for ohmic or Schottky contacts can also cause radially changing \( \rho_c \). Our model can be applied to characterize electrical properties in nanoscale thin film contacts, circular gate transistors (CGTs) [21], nanorod [22], nanowire [23], nano-fiber [16], and novel 2D material based devices [24].

The tunneling type of nanocontacts, where a thin (in nanometer or sub-nanometer range) interfacial layer (vacuum or insulator) exists between the two contact members [15, 25, 26], are ubiquitous. The local tunneling dependent \( \rho_c \) was calculated from the Simmons formula [27, 28] in Banerjee et al [15]. Although the Simmons tunneling current formulas [27, 28] reveal basic scaling and parametric dependence of the \( J-V \) profiles in metal-insulator-metal (MIM) nanogaps for low voltages, they ignore the effects of exchange correlation potential and the space charge potential inside the gap, which can modify the tunneling current density by several orders of magnitude [18, 19]. Here we incorporate a more accurate quantum analysis based on the self-consistent Schrödinger-Poisson solutions [18, 19], into the 2D circular TLM to calculate the local voltage dependent tunneling resistivity along the radial contact length. We find that the contact resistance is voltage dependent, and for intermediate voltages when the tunneling junction is operated in the field emission regime [18, 19], the dependence is the strongest. We also find that the radial current distribution is highly nonhomogeneous. This non-homogeneity can be manipulated by engineering the contact layer properties and geometry radially.

In section 2, the formulation of our 2D CTLM is presented. Results and discussions are presented in section 3, where we consider two cases. Firstly, we assume constant specific contact resistivity along the radial contact length and obtain analytical expressions for the local voltage, current, and total contact resistance. Secondly, we perform numerical calculations for nanocontacts with spatially dependent contact resistivity induced by local quantum tunneling phenomenon [18, 19]. Summary and suggestions for future research are given in section 4. Although we focus on tunneling type electrical contacts here, the proposed 2D CTLM is general and can be used for other types of circular and annular electrical contacts, such as nanoscale ohmic contacts and Schottky contacts based on 2D materials heterostructure [3, 20, 29, 30].

2. Formulation

Consider a circular (ring) contact formed between two conducting thin films or layers, as shown in figures 1(a) and (b). The outer radius of thin film 2 is \( r_o \) and the inner radius of both the films is \( r_i \). A thin resistive interface layer of thickness \( D \) is sandwiched between them. Following Reeves [11–13], we modified the basic Cartesian geometry lumped circuit transmission line model (TLM) [8, 9, 14, 31] for circular structures, as shown in figure 1(c). The sheet resistance of the two conductors is \( R_{sh1} \) and \( R_{sh2} \), respectively. The radially dependent specific interfacial resistivity (also termed specific contact resistivity) is \( \rho_c(r) \), which is either predefined or calculated from the local tunneling current in the case of an insulating tunneling layer [18, 19, 27, 28, 32].

In the contact region in figure 1(c), when \( \Delta r \to 0 \), Kirchhoff’s laws for current and voltage give the following equations,

\[
\frac{dI_1(r)}{dr} = 2\pi r J_1(r), \tag{1a}
\]

\[
\frac{dV_1(r)}{dr} = \frac{I_1(r) R_{sh1}}{2\pi r}, \tag{1b}
\]

\[
\frac{dI_2(r)}{dr} = -2\pi r J_2(r), \tag{1c}
\]

\[
\frac{dV_2(r)}{dr} = \frac{I_2(r) R_{sh2}}{2\pi r}, \tag{1d}
\]

where \( I_1(r) \) and \( I_2(r) \) represent the currents flowing at \( r \) along the radial direction of thin films 1 and 2, respectively, and \( V_1(r) \) and \( V_2(r) \) are the local voltages at \( r \) along the radial direction of thin films 1 and 2, respectively. \( J_1(r) = V_2(r) / \rho_c(r) \) and \( V_1(r) = V_1(r) - V_2(r) \) are the local current density and the local voltage drop across the contact interface at \( r \), respectively.

From equations 1(a) and 1(c), \( I_1(r) + I_2(r) = I_{tot} \) is constant, where \( I_{tot} \) is the total current in the circuit to be determined from the following boundary conditions for equation (1),

\[
V_1(r = r_o) = V_o, I_1(r = r_i) = 0, I_2(r = r_o) = 0, V_2(r = r_i) = 0, \tag{2}
\]

where we assume the voltage of the upper contact member at \( r = r_i \) is 0 and the external voltage \( V_o \) is applied at \( r = r_o \) to the lower contact member. Note that \( I_1(r = r_o) = I_{tot}, I_2(r = r_i) = I_{tot} \), and \( I_{tot} = \int_0^r 2\pi r J_2(r) \, dr \). From equations (1) and (2), we get \( V_1'(r = r_o) = I_{tot} R_{sh1}/2\pi r_o, V_1'(r = r_i) = 0, V_2'(r = r_o) = 0, V_2'(r = r_i) = I_{tot} R_{sh2}/2\pi r_i \), where a prime denotes a derivative with respect to \( r \). For the contact model in figure 1(c), the contact resistance is defined as,

\[
R_c = \frac{V_1(r_o) - V_2(r_i)}{I_{tot}} = \frac{V_o}{I_{tot}}. \tag{3}
\]

For convenience, we introduce non-dimensional quantities, \( \bar{r} = r/r_o, \beta = r_i/r_o, \bar{\rho}_c(r) = \rho_c(r) / (R_{sh1} r_o^2), R_{sh1} = R_{sh1}/R_{sh1}, J_1(r) = J_1(r) R_{sh1}/V_o, V_1(r) = V_1(r)/V_o, V_2(r) = V_2(r)/V_o, R_c = R_c 2\pi/r_o, \) and \( \alpha = I_{tot}/I, \) where \( I = 2\pi V_o/R_{sh1} \). In normalized forms,
equation (1) can be written into the following coupled second order differential equations,

\[
\frac{d^2 \bar{V}_1}{dr^2} + \frac{1}{r} \frac{d \bar{V}_1}{dr} - \frac{\bar{V}_1 - \bar{V}_2}{\rho_c(r)} = 0, \quad (4a)
\]

\[
\frac{d^2 \bar{V}_2}{dr^2} + \frac{1}{r} \frac{d \bar{V}_2}{dr} + \frac{R_{sh2}}{\rho_c(r)} \left( \bar{V}_1 - \bar{V}_2 \right) = 0. \quad (4b)
\]

Note that \( \bar{V}_g(\bar{r}) = \bar{V}_1(\bar{r}) - \bar{V}_2(\bar{r}) \) and \( \bar{T}_c(\bar{r}) = \bar{V}_g(\bar{r}) / \rho_c(\bar{r}) \).

The corresponding boundary conditions to equation (4) are,

\[
\bar{V}_1(\bar{r} = 1) = 1, \quad \bar{V}_1'(\bar{r} = 1) = \alpha, \quad \bar{V}_1'(\bar{r} = \beta) = 0, \quad (5a)
\]

\[
\bar{V}_2(\bar{r} = \beta) = 0, \quad \bar{V}_2'(\bar{r} = 1) = 0, \quad \bar{V}_2'(\bar{r} = \beta) = \frac{\alpha R_{sh2}}{\beta}, \quad (5b)
\]

and the normalized total current,

\[
\alpha = I_{tot}/I = \int \frac{1}{\beta} \bar{T}_c(\bar{r}) d\bar{r}. \quad (5c)
\]

Equations (4) and (5) are solved to give the voltage distribution along and across the contact interface as well as the total contact resistance, for a given electrical contact (figure 1) with radially dependent interface specific contact resistivity \( \rho_c(\bar{r}) \), following a similar procedure as described in [15]. Equations (4) and (5) can be solved numerically for arbitrary radial dependence of specific contact resistivity \( \rho_c(\bar{r}) \). Here, we focus on two special cases of practical importance. We first consider the case of constant \( \rho_c \), where analytical solutions can be obtained (section 3.1). This serves to validate our numerical approach. We then consider the effects of radially dependent \( \rho_c(\bar{r}) \) on the tunneling type electrical contacts (section 3.2). The one-dimensional MIM quantum tunneling equations [18, 19] are coupled with equations (4) and (5) and are solved self-consistently.

3. Results and discussion

3.1. Constant specific contact resistivity \( \rho_c \), along the radial contact length

For the special case of constant specific contact resistivity \( \rho_c \), equation (4) can be rewritten as,

\[
\frac{d^2 \bar{V}_1}{dr^2} + \frac{1}{r} \frac{d \bar{V}_1}{dr} - \frac{\bar{V}_1 - \bar{V}_2}{\rho_c} = 0. \quad (6)
\]

The corresponding boundary conditions from equations (5a) and (5b) are,

\[
\bar{V}_g(\bar{r} = 1) = \alpha, \quad \bar{V}_g'(\bar{r} = \beta) = -\frac{\alpha R_{sh2}}{\beta}. \quad (7)
\]

Using equation (7), the solution to equation (6) is,

\[
\bar{V}_g(\bar{r}) = a I_0(\lambda \bar{r}) + b K_0(\lambda \bar{r}), \quad \bar{r} > 0 \quad (8)
\]

where \( I_0 \) and \( K_0 \) are the zeroth order modified Bessel functions of the first and second kind respectively and \( \lambda = \sqrt{(1 + R_{sh2})/\rho_c} \). The constants \( a \) and \( b \) are calculated from the boundary conditions as, \( a = C/(CX + DY), \) \( b = D/(CX + DY). \) The expressions of \( X, Y, C, \) and \( D \) are,

\[
X = I_0(\lambda \beta) - I_0(\lambda \beta) - I_0(\lambda) + \beta I_1(\lambda \beta) \ln \beta, \quad \lambda = \sqrt{(1 + R_{sh2})/\rho_c},
\]

\[
Y = K_0(\lambda \beta) - K_0(\lambda \beta) - K_0(\lambda) + \beta K_1(\lambda \beta) \ln \beta, \quad \lambda = \sqrt{(1 + R_{sh2})/\rho_c},
\]

\[
C = \frac{R_{sh2} K_1(\lambda \beta) + \beta K_1(\lambda \beta)}{\lambda^2 \beta K_1(\lambda \beta)}, \quad \lambda = \sqrt{(1 + R_{sh2})/\rho_c},
\]

\[
D = \frac{R_{sh2} I_1(\lambda \beta) + \beta I_1(\lambda \beta)}{\lambda^2 \beta I_1(\lambda \beta)}, \quad \lambda = \sqrt{(1 + R_{sh2})/\rho_c},
\]

where \( I_1 \) and \( K_1 \) are the first order modified Bessel functions of the first and second kind respectively.
The normalized contact resistance is,
\begin{equation}
\overline{R}_c = \frac{V_1(1) - V_2(\beta)}{\alpha} = 1/\alpha = (CX + DY).
\end{equation}

Figure 2 shows the profiles of voltage drop $V_a(\bar{r})$ along the radial contact length $\bar{r}$ for a parallel annular thin film contact (figure 1) for different inner to outer radius ratio $\beta$ (figure 2(a)), specific contact resistivity $\overline{\rho_c}$ (figure 2(b)), and sheet resistance ratio $R_{sh2}$ (figure 2(c)). Note that, since $\overline{\rho_c}$ is constant along $\bar{r}$ here, the profiles of contact current density $I_c(\bar{r}) = \overline{V}_a(\bar{r})/\overline{\rho_c}$ follow those of $\overline{V}_a(\bar{r})$. The voltage drop across the contact interface increases with increasing inner radius to outer radius ratio $\beta$ and specific contact resistivity $\rho_c$. For similar contacting members ($R_{sh2} = R_{sh2}/R_{sh1} = 1$) the maximum voltage drop occurs at the inner edge ($r = r_o$) of the annular contact (see figures 2(a) and (b)). This is because the modified Bessel function of the second kind ($K_0$ term in equation (8)) increases sharply near the center. Physically this means the current in the contact interface is mostly crowded near $r = r_o$. The current spreads out as it flows away from the center through the least resistive path. Figure 2(c) shows a similar trend in $V_a(\bar{r})$ for dissimilar contacting members with $R_{sh2} > 1$. In fact, the current crowding at the inner edge ($r = r_i$) increases with increasing $R_{sh2}$. The voltage drop (and the contact current density) at the outer edge ($r = r_o$) increases with decreasing $R_{sh2}$. For $R_{sh2} \leq 0.1$, the majority of the contact current flows near $r = r_o$. It is interesting to note from figure 2(a) that the voltage drop profiles are highly asymmetric at the two edges ($r = r_i$, $r = r_o$) of the annular contact under study (figure 1) when $\beta$ is small, and the asymmetry reduces as $\beta$ increases. For the limiting case of $\beta \to 1$ (i.e. $r_i \approx r_o$), CTLM reduces to the planar limit [15], where the maximum voltage drop occurs at both the edges ($V_a(r = r_i) \approx V_a(r = r_o)$) and the minimum occurs at $(r_i + r_o)/2$, making the profiles symmetric.

The normalized contact resistance $\overline{R}_c$ is calculated from equation (9) and plotted in figures 3, 4, and 5 as functions of inner radius to outer radius ratio $\beta$, normalized specific contact resistivity $\overline{\rho_c}$, and sheet resistance ratio of the two contacting members $R_{sh2}$, respectively. Figures 3(a) and (b) show that for $\beta < 0.8$, $\overline{R}_c$ decreases with $\beta$ when $R_{sh2}$ is high or $\overline{\rho_c}$ is low. Figures 4(b) and 5(b) also confirm this behavior. However, when $\beta$ is increased above 0.8, $\overline{R}_c$ increases drastically with $\beta$. Larger $\beta$ means shorter radial contact length $r_o - r_i$ (for a fixed $r_i$ or $r_o$), resulting in higher total contact resistance for the annular contact structure. In general, $\overline{R}_c$ increases with the specific contact resistivity $\rho_c$ or the sheet resistance ratio $R_{sh2}$. Profiles of total contact resistance for the case of $R_{sh2} = 0$ are also plotted in figures 3, 4 and 5 as dashed lines. When $R_{sh2} \to 0$, equation (9) becomes,
\begin{equation}
\overline{R}_c = \frac{K_1(\lambda \beta) I_1(\lambda \beta) K_0(\lambda)}{\lambda [K_1(\lambda \beta) I_1(\lambda) - K_0(\lambda) I_1(\lambda \beta)]},
\end{equation}
with $\lambda = \sqrt{1/\overline{\rho_c}}$. Note that equation (10) is identical to the expression typically used for metal-semiconductor contact [9]. The difference between solid lines (equation (9)) and dashed lines (equation (10)) decreases when $\overline{\rho_c}$ or $\beta$ is large, as shown in figures 3(b) and 4(b).

The dotted lines in figures 3(a), 4(b), and 5(b) are calculated from the contact resistance for parallel Cartesian contacts, that is, equation (8) of [15]. Note that the spatial dimensions were normalized by the contact length $L (= r_o - r_i$ in circular case) in [15], whereas they are normalized by the outer radius $r_o$ for the circular case. To make the normalization consistent for direct comparison, we multiply the normalized specific contact resistivity by $1/\beta$ before inserting into equation (8) of [15], which is multiplied by $(1 - \beta)$ to obtain the dotted lines in figures 3(a), 4(b), and 5(b). For $\beta > 0.9$, the profiles of annular and Cartesian contact resistance match exceptionally well, as CTLM approaches the limit of Cartesian TLM.

3.2. Tunneling dependent radially varying contact resistivity $\rho_c$

Next, we consider the case where the parallel annular contacts are formed through a tunneling interface layer between the two annular contact members. In this case, due to the nonlinear current density–voltage ($J - V$) characteristic of metal-insulator-metal (MIM) tunnel junctions, specific contact resistivity $\rho_c$ varies radially. For simplicity, we have made the following assumptions: (1) the thickness of the interfacial insulating film in the contact area is uniform and (2) the insulating film is sufficiently thin (in the nano- or sub-nano-meter scale) so that charge trapings are ignored [33, 34].

The local contact current density $J_c(\bar{r})$ at any location $\bar{r}$ from contact member 1 to contact member 2 is calculated based on the self-consistent 1D Schrödinger–Poisson solutions in the MIM junction [18, 19]. This quantum model includes emissions from both cathode (contacting member 2) and anode (contacting member 1), the effects of image charge potential [19], space charge, and exchange correlation potentials [35]. For given values of the work function of the two contact members $W_{1,2}$, electron affinity $X$, thickness $D$, and relative permittivity $\varepsilon_r$ of the insulator layer, the local contact current density $J_c(\bar{r})$ can be calculated from this 1D quantum model for an input of the contact voltage drop $V_a(\bar{r})$ at any location $\bar{r}$ [18, 19]. The calculation of this $J_c(\bar{r})$: $V_a(\bar{r})$ relation is coupled with CTLM, equations (4), (5), and solved self-consistently.

We keep the same normalization as in section 2. Since solving the coupled quantum tunneling model [18, 19] and CTLM is time expensive, we calculate the one dimensional tunneling current density separately for the given MIM parameters ($W_1, W_2, D, \varepsilon_r, X$), over a wide range of bias voltages. The obtained $J - V$ curves are normalized (as in section 2) and then fitted with polynomials. Those curve-fitted equations are used to find the specific contact resistivity $\rho_c(\bar{r}) = \overline{V}_a(\bar{r})/\overline{I}_a(\bar{r}) = (\overline{V}_a(\bar{r}) - \overline{V}_b(\bar{r})) / \overline{I}_a(\bar{r})$, which is then inserted into the CTLM equations, equations (4) and (5), to give a self-consistent solution to the voltage and current profiles, as well as the contact resistance for the circular (annular) tunneling contact.

As an example, we consider Cu-vacuum-Cu circular thin film contacts. For our calculations, sub-nanometer scale interfacial layer thicknesses are assumed for the tunneling
Figure 2. Normalized voltage drop across the contact interface $V_g(\bar{r})$, along the radial direction of an annular contact with uniform contact resistivity, for different values of (a) inner radius to outer radius ratio $\beta$, with $\bar{\rho}_c = 1$ and $\bar{R}_{sh2} = 1$, (b) specific contact resistivity $\bar{\rho}_c$, with $\beta = 0.1$ and $\bar{R}_{sh2} = 1$, (c) sheet resistance ratio $\bar{R}_{sh2}$, with $\beta = 0.1$ and $\bar{\rho}_c = 1$. All the quantities are in their normalized forms defined in section 2.

Figure 3. Normalized contact resistance $\bar{R}_c$ of the annular contact (figure 1) as a function of inner radius to outer radius ratio $\beta$ for different (a) normalized sheet resistance of contacting member 2, $\bar{R}_{sh2}$, and (b) normalized specific contact resistivity $\bar{\rho}_c$. The dotted lines in (a) are calculated from equation (8) of [15], that is, for Cartesian parallel electrical contacts. Dashed lines are for equation (10), the limiting case of $\bar{R}_{sh2} \to 0$.

Figure 4. Normalized contact resistance $\bar{R}_c$ of the annular contact (figure 1) as a function of normalized specific contact resistivity $\bar{\rho}_c$ for different (a) normalized sheet resistance of contacting member 2, $\bar{R}_{sh2}$, and (b) inner radius to outer radius ratio $\beta$. In (a), $\beta = 0.1$, and in (b), $\bar{R}_{sh2} = 1$. Dashed lines are for equation (10), the limiting case of $\bar{R}_{sh2} \to 0$. The black dotted line in (b) is calculated from equation (8) of [15], that is, for Cartesian parallel electrical contacts.
Figure 5. Normalized contact resistance $\overline{R}_c$ of the annular contact (figure 1) as a function of sheet resistance ratio $R_{sh2}$ for different (a) normalized specific contact resistivity $\bar{\rho}_c$ and (b) inner radius to outer radius ratio $\beta$. In (a), $\beta = 0.1$, and in (b), $\bar{\rho}_c = 1$. Dashed lines are for equation (10), the limiting case of $R_{sh2} \to 0$. The black dotted line in (b) is calculated from equation (8) of [15], that is, for Cartesian parallel electrical contacts.

Figure 6. Tunneling current density across the contact interface $J_c(r)$ for different (a) input voltage $V_0$, with fixed $r_0 = 50$ nm, $\beta = 0.01$, and $D = 0.6$ nm; (b) inner radius to outer radius ratio $\beta$, with fixed $r_0 = 50$ nm, $V_0 = 1$ V, and $D = 0.6$ nm; (c) outer radius $r_0$, with fixed $V_0 = 1$ V, $\beta = 0.01$, and $D = 0.6$ nm; (d) interfacial layer thickness $D$, with fixed $r_0 = 50$ nm, $\beta = 0.01$, and $V_0 = 1$ V. All the material properties are specified in the main text. Solid lines are for self-consistent numerical calculations using equations (4) and (5), and MIM quantum tunneling formulations [18, 19]. Dashed lines are for analytical calculations from equation (8) with $\rho_c$ being constant, calculated using $V_f = V_0$ in the MIM quantum model.
type of electrical contacts [25, 36, 37]. The dimensions of the contacting members are assumed to be in nanoscale. We considered a wide range of electrode diameter, 10–160 nm, as electrodes of this range are common in transistors [38, 39], nanowire, nanofiber, and nanorod based novel devices [40–42]. Even though these nano structures are often referred to as one-dimensional because of their smaller diameters and longer lengths, our study shows that for precise characterization, two-dimensional analysis is necessary. In our calculation, sheet resistance of both the contacting members is estimated as

\[ \rho_s = \frac{V_i}{I} \]

The total contact resistance \( R_c \) across the Cu-vacuum-Cu contact interface as functions of input voltage \( V_0 \) for different (a) outer radius \( r_o \), with fixed \( \beta = 0.01 \) and \( D = 0.6 \) nm; (b) inner radius to outer radius ratio \( \beta \), with fixed \( r_o = 50 \) nm and \( D = 0.6 \) nm; (c) interfacial layer thickness \( D \), with fixed \( r_o = 50 \) nm and \( V_0 = 1 \) V. All of the material properties are specified in the main text. Solid lines are for self-consistent numerical calculations using equations (4) and (5), and MIM quantum tunneling formulations [18, 19]. The black dotted line in (a) is calculated using Simmons tunneling current formula [15, 27] and equations (4) and (5) for \( r_o = 5 \) nm. Dashed lines are for analytical calculations from equations (8) and (9) with \( \rho_s \) calculated using \( V_i = V_0 \) in the 1D MIM tunneling model.

Figure 7. The total contact resistance \( R_c \) across the Cu-vacuum-Cu contact interface as functions of input voltage \( V_0 \) for different (a) outer radius \( r_o \), with fixed \( \beta = 0.01 \) and \( D = 0.6 \) nm; (b) inner radius to outer radius ratio \( \beta \), with fixed \( r_o = 50 \) nm and \( D = 0.6 \) nm; (c) interfacial layer thickness \( D \), with fixed \( r_o = 50 \) nm and \( V_0 = 1 \) V. All of the material properties are specified in the main text. Solid lines are for self-consistent numerical calculations using equations (4) and (5), and MIM quantum tunneling formulations [18, 19]. The black dotted line in (a) is calculated using Simmons tunneling current formula [15, 27] and equations (4) and (5) for \( r_o = 5 \) nm. Dashed lines are for analytical calculations from equations (8) and (9) with \( \rho_s \) calculated using \( V_i = V_0 \) in the 1D MIM tunneling model.

for similar contact members (similar to figure 2 above). As shown in figure 6(a), because of the strong nonlinearity in the \( J-V \) characteristics of a tunneling junction, \( J_c(r) \) increases and exhibits a stronger radial dependence when the applied voltage \( V_0 \) increases. This strong voltage dependence of electrical properties of the tunneling junction is in sharp contrast with those of ohmic contacts (section 3.1), where the profiles of \( J_c(r) \) and the total contact resistance is independent of the applied voltage and the current density scales linearly with the voltage drop. Figure 6(b) shows that, as \( \beta \) decreases, that is, the contact length \( r_o - r_i \) increases, the tunneling current density \( J_c(r) \) decreases. The influence of outer radius \( r_o \) for a fixed \( \beta \) is shown in figure 6(c). The tunneling current density \( J_c(r) \) decreases when \( r_o \) increases. However, the total current in the contact structure, \( I_{tot} = \int 2 \pi r J_c(r) dr \), increases with \( r_o \) because the total contact resistance of the tunneling junction decreases with \( r_o \) (see figure 7(a)). In figure 6(d), when the gap distance \( D \) increases, the current density \( J_c(r) \) decreases quickly because the tunneling junction becomes more resistive [18, 19, 27].
Dashed lines in figure 6 are the analytical results calculated from equation (8) assuming constant tunneling contact resistivity $\rho_c$ across the radial contact length, which is the typically assumed one-dimensional tunneling contact. This $\rho_c$ is calculated from the $J-V$ curve of the metal-insulator-metal tunneling junction by setting $V_p(r) = V_o$ everywhere along the contact length. The constant contact resistivity assumptions are inadequate, especially when the tunneling thickness $D$ or inner radius to outer radius ratio $\beta$ decreases, or the applied voltage $V_o$ or outer radius $r_o$ increases. For these cases, one should solve the coupled TLM equations, equations (4) and (5), and the localized MIM tunneling equation self-consistently to give more reliable predictions.

The total contact resistance $R_c$ of the Cu-vacuum-Cu circular thin film contact is shown in figure 7 as functions of applied voltage $V_0$ and inner to outer radius ratio $\beta$. The total contact resistance $R_c$ decreases with $r_o$, as shown in figure 7(a). As $r_o$ increases, the dependence of contact resistance on $r_o$ becomes less significant. The dashed lines are for analytical solutions of the 1D tunneling model with constant $\rho_c$ calculated from equations (8) and (9) as previously stated. The difference between the 1D model (equation (9)) and self-consistent numerical calculations (equations (4) and (5)) is significant when $D$ or $\beta$ is small, or when $r_o$ or $V_0$ is large. In these regimes where the 1D tunneling model with constant $\rho_c$ approximations fail to provide reliable predictions, it is necessary to use the self-consistent numerical model.

The black dotted line in figure 7(a) is calculated using Simmons’ tunneling current formula [15, 27] and equations (4) and (5) for $r_o = 5$ nm. Clearly, the difference between the quantum based self-consistent calculations and Simmons’ formula is substantial. Simmons’ formulas, which are widely used for these kinds of studies [15, 25], are inadequate in sub-nm scale (see figure 3(a) of [19]). For low applied voltages, in the direct tunneling regime, the MIM junction behaves ohmically, thus $R_c$ varies slightly with $V_0$, as shown in figures 7(a) and (b). When the applied voltage is increased into the field
The potential barrier in the insulating layer increases with the voltage, which is a function of position along the radial contact length. As $V_0$ approaches 10 V, space charge effects become important [18, 19, 45, 46], and $R_e$ saturates, decreasing only slightly with $V_0$.

The effect of the inner radius to outer radius ratio of the upper contact member ($\beta$) on the total contact resistance ($R_c$) is shown in figures 7(b)–(d), showing similar trends to figure 3(b) above for the case of constant contact resistivity $\rho_c$. Figure 7(d) shows that reducing the insulator thickness $D$ even slightly can affect the contact resistance substantially.

Next, we extend our calculations for Cu thin film contacts to different metals: magnesium (Mg), aluminum (Al), gold (Au), and platinum (Pt). The resistivity of a metal thin film $\rho_{film}$ is usually different than the metal’s bulk resistivity $\rho_{bulk}$. $\rho_{film}$ for the metals mentioned above are calculated from $\rho_{film}/\rho_{bulk} = 4/[3(t/l)\log(I/t)]$ for $t < l$ and $\rho_{film}/\rho_{bulk} = 1 + 3/8(l/t)$ for $t > l [47, 48]$, where $l$ is the electron mean free path and $t$ is the thickness of the thin film (figure 1). The work function [49], bulk resistivity $\rho_{bulk}$, and electron mean free path $l$ [47, 50, 51] for the metals are given in table 1. The film thickness is assumed to be $t = 10$ nm for all the cases.

Table 1. Material parameters of the contacting metals in Cu-insulator-metal contacts.

<table>
<thead>
<tr>
<th>Metal</th>
<th>$W_2$ (eV)</th>
<th>$\rho_{bulk}$ (Ωm)</th>
<th>$l$ (nm)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Mg</td>
<td>3.68 [52]</td>
<td>4.46 $\times$ 10$^{-8}$ [53]</td>
<td>22.3 [50]</td>
</tr>
<tr>
<td>Al</td>
<td>4.08 [52]</td>
<td>2.65 $\times$ 10$^{-8}$ [54]</td>
<td>18.9 [50]</td>
</tr>
<tr>
<td>Au</td>
<td>5.1 [19]</td>
<td>2.24 $\times$ 10$^{-8}$ [53]</td>
<td>38 [47]</td>
</tr>
<tr>
<td>Pt</td>
<td>6.35 [52]</td>
<td>10.6 $\times$ 10$^{-8}$ [54]</td>
<td>12 [51]</td>
</tr>
</tbody>
</table>

emission regime (>1 V), $R_e$ decreases sharply with $V_0$. This is because the junction is no longer ohmic and the tunneling resistivity $\rho_t$ decreases rapidly and nonlinearly with the junction voltage, which is a function of position along the radial contact length. As $V_0$ approaches 10 V, space charge effects become important [18, 19, 45, 46], and $R_e$ saturates, decreasing only slightly with $V_0$.

4. Summary

In this paper, we present a self-consistent tunneling model to characterize parallel electrical contacts between two annular thin films. Our model considers the radial variation of contact resistivity along the contact length. We solved the CTLM equations for constant specific contact resistivity and radially varying, tunneling dependent specific contact resistivity along the contact length. Our study provides a thorough understanding of the contact tunneling resistance, current, and voltage distributions across nano and sub-nano scale MIM junctions in circular ring type electrical contacts using an inexpensive model from which many general scalings may be obtained. The effects of contact geometry (i.e. inner and outer radius of the ring contact, distance between the contact electrodes) and material properties (i.e. work function, sheet resistance of the contact members, and permittivity of the insulating layer) on the radial distributions of currents and voltages across these contacts and the overall contact resistance are studied in detail. The quantum tunneling model includes the effects of image charge, space charge, and exchange correlation potential.

It is found that the contact current density and voltage drop profiles are highly asymmetric at the two edges of the annular contact, even for similar contacting members. This is in sharp contrast to the current and voltage profiles of parallel Cartesian nanocontacts. However, the asymmetry reduces when inner radius to outer radius ratio $\beta$ increases; for $\beta \rightarrow 1$, the profiles become almost symmetric. Our calculations for tunneling type contacts show that the contact resistance $R_c$ is voltage dependent, increases sharply with $D$, and decreases with $r_o$. If $\beta$ is increased above 0.9, the $R_e$ of the annular contact increases dramatically. It is found that the analytical solutions of one-dimensional (1D) tunneling junction models (constant voltage across the whole junction) are good approximations of the actual circular (annular) contacts only when the thickness $D$ or inner radius to outer radius ratio $\beta$ is relatively large, or the applied voltage across the contact $V_0$ or outer radius $r_o$ is relatively small. Otherwise, the 1D tunneling model of constant contact resistivity becomes unreliable, and the self-consistent CTLM equations coupled with the spatially dependent tunneling current need to be used to accurately characterize the electrical contacts.

In existing CTLM [11, 12], the interface contact resistivity is almost always assumed to be constant. Thus, the contact resistivity measured using the transmission line method (TLM) would consist of possible intrinsic errors when a thin tunneling (e.g. oxide) layer at the contact interfaces is present. In this case, our model would give a more accurate evaluation of contact resistivity. The work presented here may be used to better understand the electrical conductivity of nanofiber and nanorod contacted thin-film devices, where such circular (or annular) contacts naturally exist. Furthermore, our study reveals that, by varying the contact layer properties and geometry, one can strategically design the radially dependent contact resistivity in circular contacts to achieve desired current distribution. It is worth mentioning that while the work presented here is for tunneling type contacts, our modified CTLM equations with radially varying $\rho_t$ can also be used for other types of contacts such as ohmic and Schottky contacts.

Although a TLM is less computationally expensive and easier to implement, it is a simplified approximation of practical 2D electrical contacts. Field solution methods need to be used in the future to accurately evaluate current crowding and fringing field effects, the impact of finite thickness (or length)
in the contact members, and the possible parallel component of current flows in the interface layer \[8, 15, 44, 55, 56\]. The effects of reactive elements in the circuit, AC response, and imperfect insulator layer on the electrical properties of tunneling type contacts may also be studied in the future. Future studies may also consider the influence of properties of the materials forming the contact and the possible interaction of the semiconductor (or insulator) films under the contact region, such as Schottky barrier, band bending, charge redistribution, and material defects.

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